

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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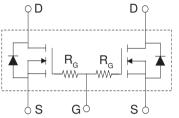
TrenchMV[™] Power MOSFETs Common-Gate Pair

IXTL2x240N055T

 $V_{DSS} = 55 V \\ I_{D25} = 2x140 A \\ R_{DS(on)} \le 4.4 m\Omega$

(Electrically Isolated Back Surface)

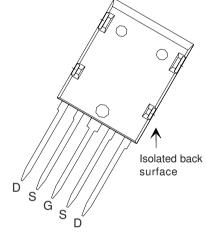
N-Channel Enhancement Mode Avalanche Rated



ISOPLUS i5-Pak™	(IXTL)
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Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	T_J = 25°C to 175°C T_J = 25°C to 175°C; R_{GS} = 1 M Ω	55 55	V	
V _{GSM}	Transient	± 20	V	
I _{D25}	T _c = 25°C (Combined die total = 280 A)	140	Α	
LRMS	Package Current Limit, RMS (Combined die total = 150 A)	75	Α	
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, pulse width limited by $T_{\rm JM}$	650	Α	
I _{AS} E _{AS}	$T_{c} = 25^{\circ}C$ $T_{c} = 25^{\circ}C$	25 1.0	A J	
dv/dt	$I_{_{S}} \leq I_{_{DM}}$, di/dt \leq 100 A/ μ s, $V_{_{DD}} \leq V_{_{DSS}}$ $T_{_{J}} \leq$ 175°C, $R_{_{G}} = 3.3~\Omega$	3	V/ns	
P_{D}	T _C = 25°C	150	W	
T _J T _{JM} T _{stg}		-55 +175 175 -55 +175	0° 0° 0°	
T _L	1.6 mm (0.062 in.) from case for 10 s Plastic body for 10 seconds	300 260	°C	
V _{ISOL}	50/60 Hz, $t = 1$ minute, $I_{ISOL} < 1$ mA, RMS	2500	V	
F _c	Mounting force	30170 / 736	N/lb.	
Weight	Package	9	g	

Symbol $(T_J = 25^{\circ}C)$	Test Conditions unless otherwise specified)		Cha Min.	racteris Typ.	stic Values Max.
BV _{DSS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		55		V
$V_{GS(th)}$	$V_{DS}^{}=V_{GS}^{},I_{D}^{}=250\;\mu A$		2.0		4.0 V
l _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$				± 200 nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T _J = 150°C			5 μA 250 μA
R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}, \text{ Note}$	1, 2			4.4 m Ω



G = Gate D = DrainS = Source

Features

- Ultra-low On Resistance
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
- easy to drive and to protect
- 175 °C Operating Temperature

Advantages

- Easy to mount
- Space savings
- High power density

Applications

- Automotive
 - Motor Drives
 - High Side Switch
 - 12V Battery
 - ABS Systems
- DC/DC Converters and Off-line UPS
- Primary- Side Switch
- High Current Switching Applications

All ratings and parametric values are per each MOSFET die unless otherwise specified.



Symbol	Test Conditions $(T = 25^{\circ}C)$		Characteristic Values nless otherwise specified)		
		Min.		Max	
g _{fs}	$V_{DS} = 10 \text{ V}; I_{D} = 60 \text{ A}, \text{ Note 1}$	80	132		S
\mathbf{R}_{G}			3		Ω
C _{iss}			7600		pF
C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1240		pF
C _{rss}			260		pF
$\mathbf{t}_{d(on)}$			40		ns
t _r	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 25 \text{A}$		54		ns
$\mathbf{t}_{d(off)}$	$R_{G} = 5 \Omega \text{ (External)}$		63		ns
t,			75		ns
$Q_{g(on)}$			170		nC
\mathbf{Q}_{gs}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 25 \text{A}$		32		nC
\mathbf{Q}_{gd}			48		nC
\mathbf{R}_{thJC}				1.0	°C/W
R_{thCS}			0.25		°C/W

Source-Drain Diode

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Characteristic Values

T_J = 25°C unless otherwise specified)

Min. | Typ. | Max.

Symbol	lest Conditions	win.	тур.	мах.	
I _s	$V_{GS} = 0 V$			240	Α
I _{SM}	Pulse width limited by T _{JM}			650	Α
V_{SD}	$I_{F} = 50 \text{ A}, V_{GS} = 0 \text{ V}, \text{ Note 1}$			1.0	V
t _{rr}	$I_F = 25 \text{ A}, -di/dt = 100 \text{ A}/\mu\text{s}$		40		ns
	$V_R = 30 \text{ V}, V_{GS} = 0 \text{ V}$				

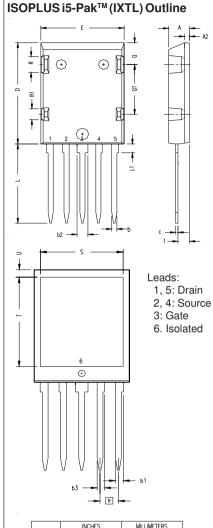
Notes: 1. Pulse test, $t \le 300 \mu s$, duty cycle d $\le 2 \%$;

T--4 0--414---

2. Drain and source Kelvin contact must be located less than 5 mm from the plastic body.

ADVANCETECHNICALINFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.



0.41	INCHES		MILLIMETERS		
SYM	MIN	MAX	MIN	MAX	
A	.190	.205	4.83	5.21	
A1	.102	.118	2.59	3.00	
A2	.046	.055	1.17	1.40	
b	.045	.055	1.14	1.40	
ь1	.063	.072	1.60	1.83	
b2	.100	.110	2.54	2.79	
b3	.058	.068	1.47	1.73	
С	.020	.029	0.51	0.74	
D	1.020	1.040	25.91	26.42	
E	.770	.799	19.56	20.29	
е	.150 [.150 BSC		BSC	
L	.780	.820	19.81	20.83	
L1	.080	.102	2.03	2.59	
Q	.210	.235	5.33	5.97	
Q1	.490	.513	12.45	13.03	
R	.150	.180	3.81	4.57	
R1	.100	.130	2.54	3.30	
S	.668	.690	16.97	17.53	
T	.801	.821	20.34	20.85	
U	065	080	1.65	2.03	

Note:

- 1. TAB 6 Electrically isolated from the other pins.
- 2. All leads and tab are tin plated.